

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: J.-S. Mok et al. Attorney Docket No.: LEPA121687
Application No.: 10/677,182 Art Unit: 1765 / Confirmation No: 8329
Filed: October 2, 2003 Examiner: S. Ahmed
Title: METHOD OF FORMING SOLDER RESIST PATTERN

AMENDMENT AFTER FINAL

Seattle, Washington 98101

January 23, 2007

TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows.